

#### Single N-Channel Enhancement Mode MOSFET

#### **Feature**

60V/160A

 $R_{DS(ON)} = 2.4 \text{ m}\Omega \text{ (typ.)} @ V_{GS} = 10V$ 

 $R_{DS(ON)}$ = 3.6 m $\Omega$  (typ.) @ V<sub>GS</sub> = 4.5V

- 100% Avalanche Tested
- Reliable and Rugged
- Halogen- Free Devices Available (RoHS Compliant)

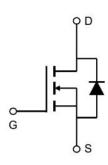
#### **Pin Description**



TO-220FB-3L

#### **Applications**

- High Frequency Point-of-Load Synchronous Buck Converter
- Power Tool Application
- Networking DC-DC Power System



Single N-Channel MOSFET

## **Ordering and Marking Information**



Note: HUAYI lead-free products contain molding compounds/die attach materials and 100% matte tin plateTermi-Nation finish; which are fully compliant with RoHS. HUAYI lead-free products meet or exceed the lead-Free requirements of IPC/JEDEC J-STD-020 for MSL classification at lead-free peak reflow temperature. HUAYI defines "Green" to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

HUAYI reserves the right to make changes, corrections, enhancements, modifications, and improvements to this pr-oduct and/or to this document at any time without notice.



## **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Unit	
Common Ra	tings (Tc=25°C Unless Otherwise Noted)		-	
VDSS	Drain-Source Voltage		60	V
Vgss	Gate-Source Voltage		±20	V
TJ	Maximum Junction Temperature		175	°C
Tstg	Storage Temperature Range		-55 to 175	°C
ls	Source Current-Continuous(Body Diode)	Tc=25°C	160	Α
Mounted on	Large Heat Sink		-	1
<b>I</b> DM	Pulsed Drain Current *	Tc=25°C	670	А
	0 1 0 0	Tc=25°C	160	Α
lσ	Continuous Drain Current	Tc=100°C	113	А
Б	Marriana Danca Dissipation	Tc=25°C	125	W
Po	Maximum Power Dissipation Tc=100°C		62.5	W
R₀Jc	Thermal Resistance, Junction-to-Case		1.2	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient **		62	°C/W
Eas	SinglePulsed-Avalanche Energy ***	L=0.3mH	311.2	mJ

Note: \* Repetitive rating; pulse width limited by max.junction temperature.

## **Electrical Characteristics**(Tc =25°C Unless Otherwise Noted)

Cumbal	Dovomotor	Took Conditions	HYU025N06LS1		11:4:4	
Symbol	Parameter	Test Conditions	Min	Тур.	Max	Unit
Static Cha	racteristics					
BVDSS	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V,I <sub>DS</sub> =250μA	60	-	-	V
Ipss	Drain to Source Leakage Current	V <sub>DS</sub> =60V,V <sub>GS</sub> =0V	-	-	1	μA
IDSS	Drain-to-Source Leakage Current	TJ=100°C	-	-	50	μA
$V_{GS(th)}$	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>DS</sub> =250µA	1.0	2.1	3.0	V
Igss	Gate-Source Leakage Current	$V_{GS}=\pm20V,V_{DS}=0V$	-	-	100	nA
Dpg(0),0*	Drain-Source On-State Resistance	V <sub>GS</sub> =10V,I <sub>DS</sub> =40A	-	2.4	3.2	mΩ
Rds(on)*	Diain-Source On-State Resistance	V <sub>GS</sub> =4.5V,I <sub>DS</sub> =40A	-	3.6	4.5	mΩ
Diode Cha	Diode Characteristics					
V <sub>SD</sub> *	Diode Forward Voltage	IsD=40A,Vgs=0V	-	0.85	1.3	V
<b>t</b> rr	Reverse Recovery Time	lon=10 A dlon/dt=100 A/ug	-	41.1	-	ns
Qrr	Reverse Recovery Charge	- Isb=40A,dIsb/dt=100A/μs	-	48.2	-	nC

<sup>\*\*</sup> Surface mounted on FR-4 board.

<sup>\*\*\*</sup> Limited by TJmax, starting TJ= $25^{\circ}$ C, L = 0.3mH, VDs =48V., VGs =10V.

# HYU025N06LS1P



# Electrical Characteristics (Cont.) (Tc =25°C Unless Otherwise Noted)

0	Barrary at an	Total Constitutions	HY	HYU025N06LS1		
Symbol	Parameter	Test Conditions	Min	Тур.	Max	Unit
Dynamic	Characteristics		•	•		
Rg	Gate Resistance	V <sub>GS</sub> =0V,V <sub>DS</sub> =0V,F=1MHz	-	0.58	-	Ω
Ciss	Input Capacitance	V <sub>GS</sub> =0V,	-	3915	-	
Coss	Output Capacitance	V <sub>DS</sub> =25V,	-	1310	-	pF
Crss	Reverse Transfer Capacitance	Frequency=1.0MHz	-	10.2	-	
td(ON)	Turn-on Delay Time		-	15.3	-	
Tr	Turn-on Rise Time	V <sub>DD</sub> =30V,R <sub>G</sub> =4Ω, I <sub>DS</sub> =40A,V <sub>GS</sub> =10V	-	34	-	
td(OFF)	Turn-off Delay Time		-	33	-	ns
Tf	Turn-off Fall Time		-	9.4	-	
Gate Cha	rge Characteristics					
<b>Q</b> g (10V)	Total Gate Charge		-	58.3	-	
<b>Q</b> g (4.5V)	Total Gate Charge	$V_{DS}$ =48V, $V_{GS}$ =10V, $I_{D}$ =40A	-	27.7	-	
Qgs	Gate-Source Charge		-	15.7	-	nC
Qgd	Gate-Drain Charge		-	9.7	-	

Note: \*Pulse test, pulse width  $\leq 300$ us, duty cycle  $\leq 2\%$ 



### **Typical Operating Characteristics**

**Figure 1: Power Dissipation** 

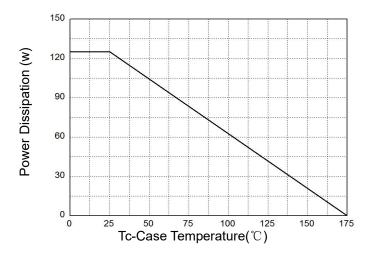


Figure 2: Drain Current

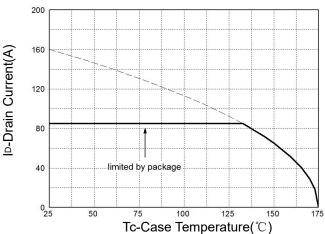
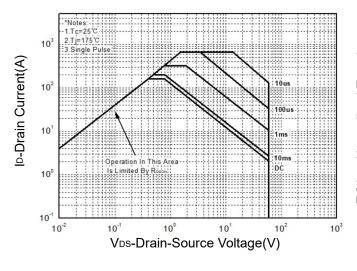
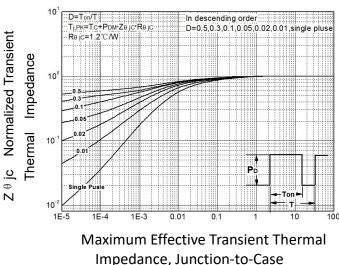


Figure 3: Safe Operation Area



**Figure 4: Thermal Transient Impedance** 



**Figure 5: Output Characteristics** 

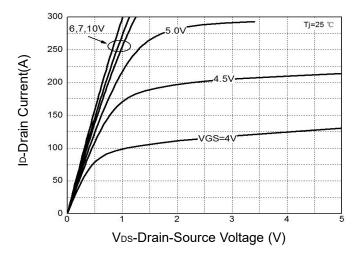
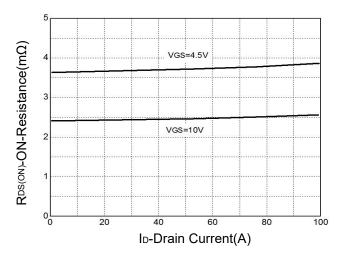


Figure 6: Drain-Source On Resistance





## **Typical Operating Characteristics(Cont.)**

Figure 7: On-Resistance vs. Temperature

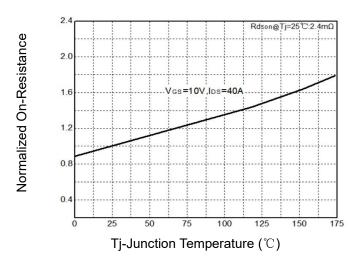


Figure 9: Capacitance Characteristics

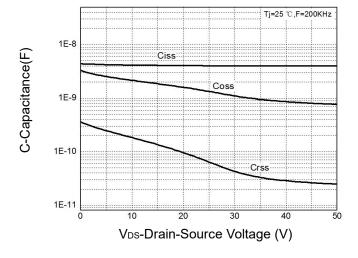
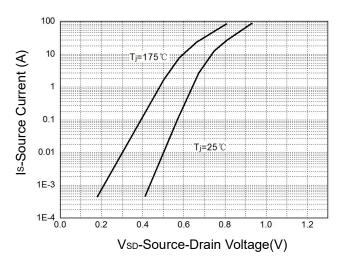
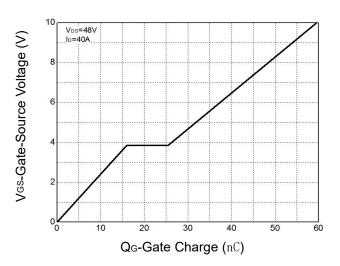


Figure 8: Source-Drain Diode Forward

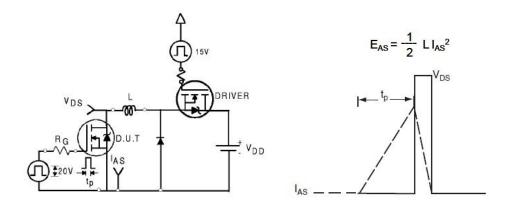


**Figure 10: Gate Charge Characteristics** 

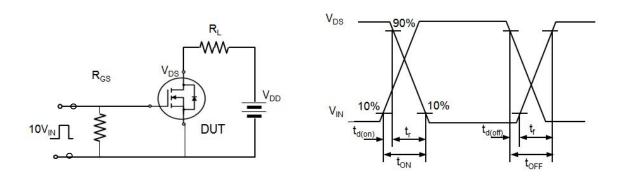




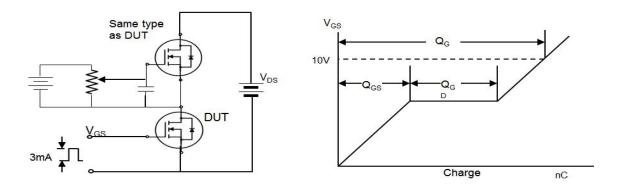
## **Avalanche Test Circuit and Waveforms**



# **Switching Time Test Circuit and Waveforms**



# **Gate Charge Test Circuit and Waveforms**



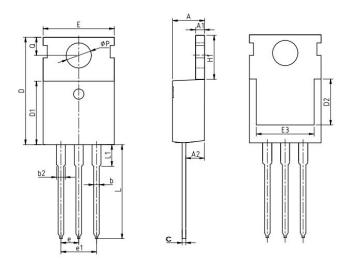


## **Device Per Unit**

Package Type	Unit	Quantity
TO-220FB-3L	Tube	50

# Package Information

#### TO-220FB-3L

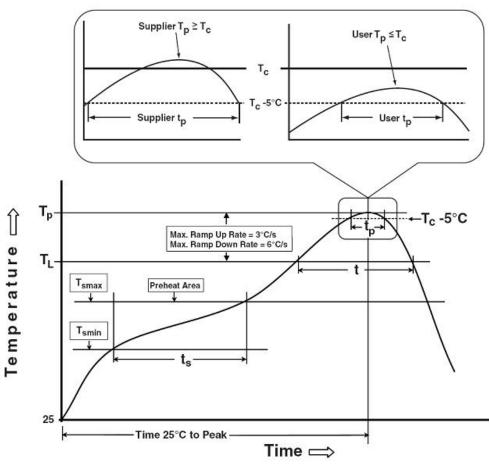


#### **COMMON DIMENSIONS**

CVMPOL	mm			
SYMBOL	MIN	NOM	MAX	
А	4.37	4.57	4.77	
A1	1.25	1.30	1.45	
A2	2.20	2.40	2.60	
b	0.70	0.80	0.95	
b2	1.17	1.27	1.47	
С	0.40	0.50	0.65	
D	15.10	15.60	16.10	
D1	8.80	9.10	9.40	
D2	5.50	-	-	
E	9.70	10.00	10.30	
E3	7.00	-	-	
е		2.54 BSC		
e1	5.08 BSC			
H1	6.25	6.50	6.85	
L	12.75	13.50	13.80	
L1	-	3.10	3.40	
ФР	3.40	3.60	3.80	
Q	2.60	2.80	3.00	



#### **Classification Profile**



#### **Classification Reflow Profiles**

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly	
Preheat & Soak	400 °C	450 °C	
Temperature min (T <sub>smin</sub> )	100 °C	150 °C	
Temperature max (T <sub>smax</sub> )	150 °C	200 °C	
Time (Tsmin to Tsmax) (t <sub>s</sub> )	60-120 seconds	60-120 seconds	
Average ramp-up rate	2 ° 0 /	3°C/second max.	
(T <sub>smax</sub> to T <sub>P</sub> )	3 °C/second max.		
Liquidous temperature (T₋)	183 °C	217 °C	
Time at liquidous (t∟)	60-150 seconds	60-150 seconds	
Peak package body Temperature	Con Classification Towns in table 1	SeeClassification Tempin table 2	
(T <sub>p</sub> )*	See Classification Temp in table 1		
Time (t <sub>P</sub> )** within 5°C of the specified	OO++ I	30** seconds	
classification temperature (T₀)	20** seconds		
Average ramp-down rate (Tpto Tsmax)	6 °C/second max.	6 °C/second max.	
Time 25°C to peak temperature	6 minutes max.	8 minutes max.	
*Tolerance for peak profile Temperature (Tp) is defined as a supplier minimum and a user maximum.			

<sup>\*\*</sup> Tolerance for time at peak profile temperature (tp) is defined as a supplier minimum and a user maximum.

# HYU025N06LS1P



Table 1.SnPb Eutectic Process – Classification Temperatures (Tc)

Package	Volume mm³	Volume mm³
Thickness	<350	≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

#### Table 2.Pb-free Process – Classification Temperatures (Tc)

Package	Volume mm³	Volume mm³	Volume mm <sup>3</sup>
Thickness	<350	350-2000	≥2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C

## **Reliability Test Program**

Test item	Method	Description
SOLDERABILITY	JESD-22, B102	5 Sec, 245°C
HTRB	JESD-22, A108	168Hrs//500Hrs/1000Hrs, Bias @ 150°C
HTGB	JESD-22, A108	168 Hrs/500Hrs/1000Hrs, V <sub>gs</sub> 100% @ 150°C
PCT	JESD-22, A102	96 Hrs, 100%RH, 2atm, 121°C
TCT	JESD-22, A104	500 Cycles, -55°C~150°C

#### **Customer Service**

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